

Product data sheet

1. General description

Planar passivated four quadrant triac in a IITO3P package intended for use in circuits where high static and dynamic dV/dt and high dl/dt can occur. This triac will commutate the full RMS current at the maximum rated junction temperature ($T_{j(max)} = 150$ °C). It is used in applications where "high junction operating temperature capability" is required.

2. Features and benefits

- High current TRIAC
- Low thermal resistance
- High junction operating temperature capability (T_{i(max)} = 150 °C)
- High voltage capability
- · Planar passivated for voltage ruggedness and reliability
- Insulated tab rated at 2500 V rms

3. Applications

- High current / high surge applications
- High power / industrial controls -- e.g. heating, motors, lighting

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Values | Unit | | | | |
|------------------|--|--|--------|------|--|--|--|--|
| Absolute | Absolute maximum rating | | | | | | | |
| V_{DRM} | repetitive peak off-state voltage | | 600 | V | | | | |
| $I_{T(RMS)}$ | RMS on-state current | full sine wave; T _{mb} ≤ 105 °C; <u>Fig. 1; Fig. 2; Fig. 3</u> | 40 | A | | | | |
| I _{TSM} | non-repetitive peak on- state current | full sine wave; t _p = 20 ms; T _{j(init)} = 25 °C; <u>Fig. 4; Fig. 5</u> | 400 | A | | | | |
| | | full sine wave; t_p = 16.7 ms; $T_{j(init)}$ = 25 °C | 440 | А | | | | |
| Tj | junction temperature | | 150 | °C | | | | |

BTA41-600B

4Q Triac

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--|---------------------------------------|--|-----|-----|-----|------|
| Static cha | racteristics | | | | | |
| I _{GT} | gate trigger current | V _D = 12 V; I _T = 0.1 A; T2+ G+ T _j = 25 °C; <u>Fig. 7</u> | - | - | 50 | mA |
| | | V_{D} = 12 V; I _T = 0.1 A; T2+ G- T _j = 25 °C; <u>Fig. 7</u> | - | - | 50 | mA |
| | | V_{D} = 12 V; I _T = 0.1 A; T2- G- T _j = 25 °C; <u>Fig. 7</u> | - | - | 50 | mA |
| | | V_{D} = 12 V; I _T = 0.1 A; T2- G+ T _j = 25 °C; <u>Fig. 7</u> | - | - | 70 | mA |
| I _H | holding current | V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u> | - | - | 80 | mA |
| V _T | on-state voltage | I _T = 56.6 A; T _j = 25 °C; <u>Fig. 10</u> | - | 1.2 | 1.5 | V |
| Dynamic | characteristics | | | | | |
| dV _D /dt rate of rise of off-sta voltage | | V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit | 750 | - | - | V/µs |
| | | $V_{DM} = 536 \text{ V}; \text{ T}_{\text{j}} = 150 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM}); exponential waveform; gate open circuit$ | 500 | - | - | V/µs |
| dl _{com} /dt | rate of change of commutating current | $V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C}; \text{ I}_{T(RMS)} = 20\text{ A}; $ $dV_{com}/dt = 20 \text{ V}/\mu\text{s}; \text{ gate open circuit}$ | 20 | - | - | A/ms |
| | | $V_D = 400 \text{ V}; \text{ T}_j = 150 \text{ °C}; \text{ I}_{T(RMS)} = 20\text{ A};$ $dV_{com}/dt = 20 \text{ V}/\mu\text{s}; \text{ gate open circuit}$ | 10 | - | - | A/ms |

5. Pinning information

| Table 2. P | Table 2. Pinning information | | | | | | | |
|------------|------------------------------|-------------------------|--------------------|----------------|--|--|--|--|
| Pin | Symbol | Description | Simplified outline | Graphic symbol | | | | |
| 1 | T1 | main terminal 1 | \bigcirc | T2-T1 | | | | |
| 2 | T2 | main terminal 2 | | Sym051 | | | | |
| 3 | G | gate | | Symoor | | | | |
| mb | n.c. | mounting base; isolated | IITO3P (SOT1292) | | | | | |

6. Ordering information

Table 3. Ordering information

| Type number | Package name | Orderable part number | Packing method | Small packing quantity | Package version | Package issue date |
|-------------|-----------------|-----------------------|-------------------|---------------------------|-----------------|-----------------------|
| BTA41-600B | IITO3P | BTA41-600BQ | Tube | 30 | SOT1292 | 21-Jul-2017 |

7. Marking

| Table 4. Marking codes | | | |
|------------------------|--|-------------------------------------|--|
| Type number | | Marking codes | |
| BTA41-600B | | BTA41-600B | |
| BTA41-600B | All information provided in this documer | nt is subject to legal disclaimers. | [©] WeEn Semiconductors Co., Ltd. 2019. All rights reserved |
| Product data sheet | 06 May 2019 | 9 | 2 / 12 |

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Values | Unit |
|---------------------|--|---|------------|------|
| V _{DRM} | repetitive peak off-state voltage | | 600 | V |
| I _{T(RMS)} | RMS on-state current | full sine wave; T _{mb} ≤ 105°C; <u>Fig. 1;</u> <u>Fig. 2; Fig. 3</u> | 40 | A |
| I _{TSM} | non-repetitive peak on- state current | full sine wave; $t_p = 20 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$; Fig. 4; Fig. 5 | 400 | A |
| | | full sine wave; t_p = 16.7 ms; $T_{j(init)}$ = 25 °C | 440 | А |
| l ² t | l ² t for fusing | t _p = 10ms; sine wave | 800 | A²/s |
| dl _⊤ /dt | rate of rise of on-state current | I _G = 150mA | 150 | A/µs |
| I _{GM} | peak gate current | t _p = 20µs | 8 | А |
| P _{GM} | peak gate power | t _p = 20µs | 40 | W |
| P _{G(AV)} | average gate power | over any 20 ms period | 1 | W |
| T _{stg} | storage temperature | | -40 to 150 | °C |
| Tj | junction temperature | | 150 | °C |

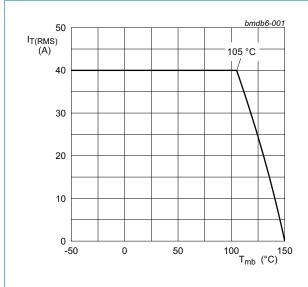
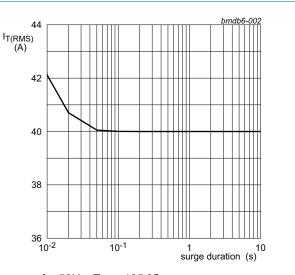


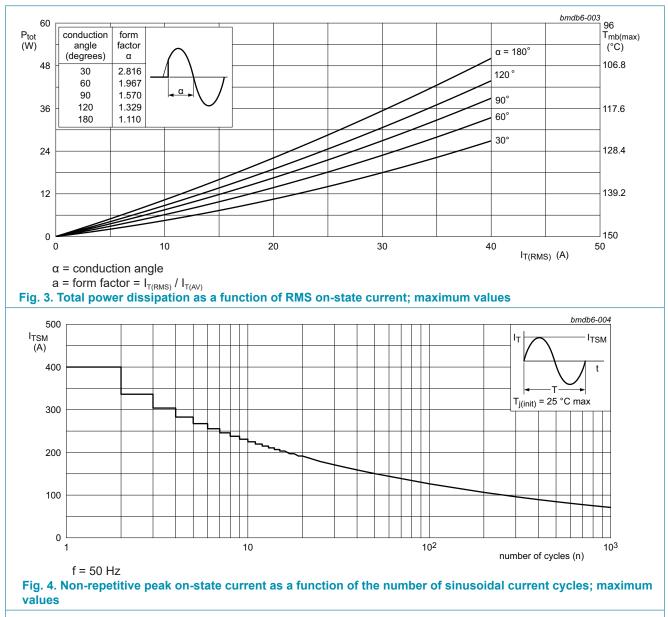
Fig. 1. RMS on-state current as a function of mounting base temperature; maximum values

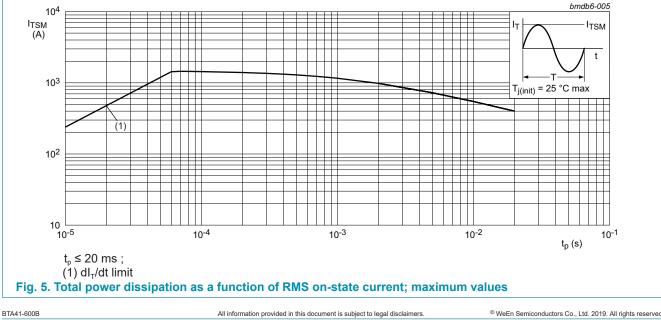




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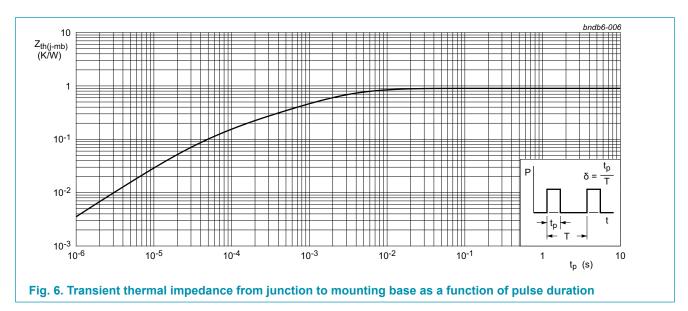
BTA41-600B 4Q Triac





9. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|--|-------------|-----|-----|-----|------|
| R _{th(j-mb)} | thermal resistance from junction to mounting base | Fig. 6 | - | - | 0.9 | K/W |
| $R_{\text{th(j-a)}}$ | thermal resistance from junction to ambient free air | in free air | - | 50 | - | K/W |



10. Isolation characteristics

| Table 6. Isolation characteristics | | | | | | | |
|------------------------------------|-----------------------|--|--|-----|-----|------|------|
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
| $V_{\text{isol}(\text{RMS})}$ | RMS isolation voltage | from all terminal to external heatsink; sinusoidal waveform; clean and dust free; 50 Hz \leq f \leq 60 Hz; RH \leq 65 %; T _h = 25 °C | | - | - | 2500 | V |

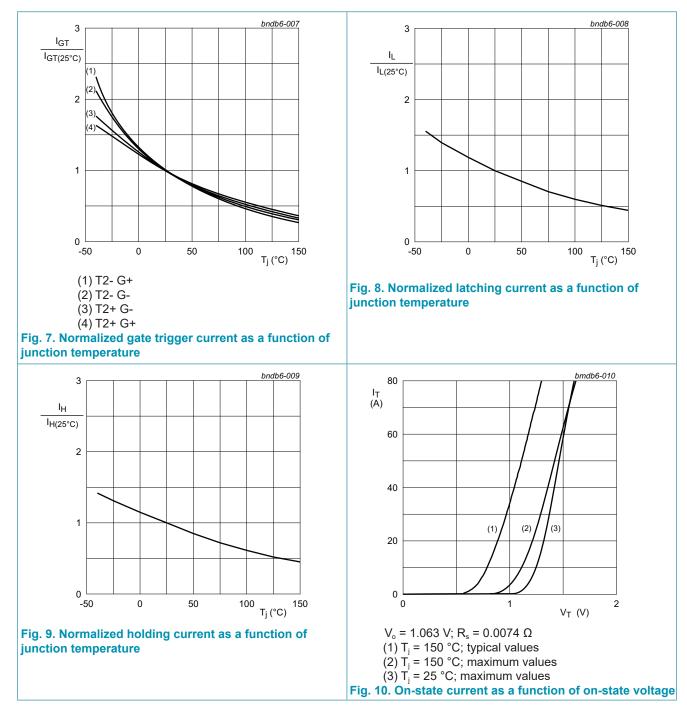
11. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---------------------------------------|--|-----------|------|-----|------|
| Static cha | racteristics | | | | | |
| I _{GT} | gate trigger current | $V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G+};$ $\text{T}_{j} = 25 \text{ °C}; \text{ Fig. 7}$ | - | - | 50 | mA |
| | | V_{D} = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 7</u> | - | - | 50 | mA |
| | | $V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2- G-};$ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$ | - | - | 50 | mA |
| | | $V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2- G+};$ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$ | - | - | 70 | mA |
| l | latching current | $V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2+ G+};$ $T_{j} = 25 \text{ °C}; \text{ Fig. 8}$ | - | - | 100 | mA |
| | | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ T2+ G-};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$ | - | - | 160 | mA |
| | | V_{D} = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 8</u> | - | - | 100 | mA |
| | | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ T2- G+};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$ | - | - | 100 | mA |
| I _H | holding current | V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u> | - | - | 80 | mA |
| V _T | on-state voltage | I _T = 56.6 A; T _j = 25 °C; <u>Fig. 10</u> | - | 1.2 | 1.5 | V |
| V _{gt} | gate trigger voltage | $V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; T_{j} = 25 \text{ °C};$ Fig. 11 | - | 0.8 | 1.3 | V |
| | | V _D = 400 V; I _T = 0.1 A; T _j = 150 °C; Fig. 11 | 0.2 | 0.45 | - | V |
| l _D | off-state current | V _D = 600 V; T _j = 25 °C | - | - | 10 | μA |
| | | V _D = 600 V; T _j = 150 °C | - | - | 2.5 | mA |
| Dynamic o | characteristics | · · · · · · · · · · · · · · · · · · · | · · · · · | | | |
| D | rate of rise of off-state voltage | $V_{DM} = 536 \text{ V}; \text{ T}_{j} = 125 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM}); exponential waveform; gate open circuit$ | 750 | - | - | V/µs |
| | | V_{DM} = 536 V; T _j = 150 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit | 500 | - | - | V/µs |
| dI _{com} /dt | rate of change of commutating current | | 20 | - | - | A/ms |
| | | $V_D = 400 \text{ V}; T_j = 150 \text{ °C}; I_{T(RMS)} = 20\text{A};$ $dV_{com}/dt = 20 \text{ V}/\mu\text{s};$ gate open circuit | 10 | - | - | A/ms |

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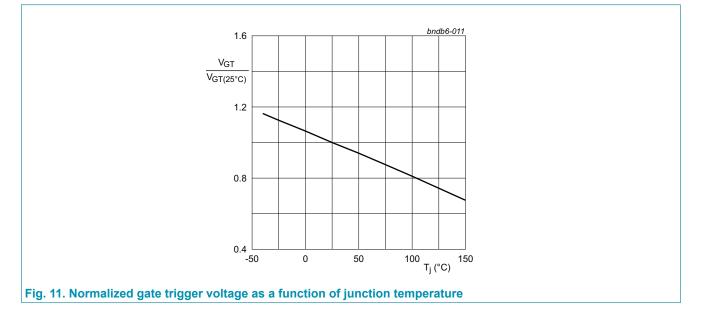
4Q Triac



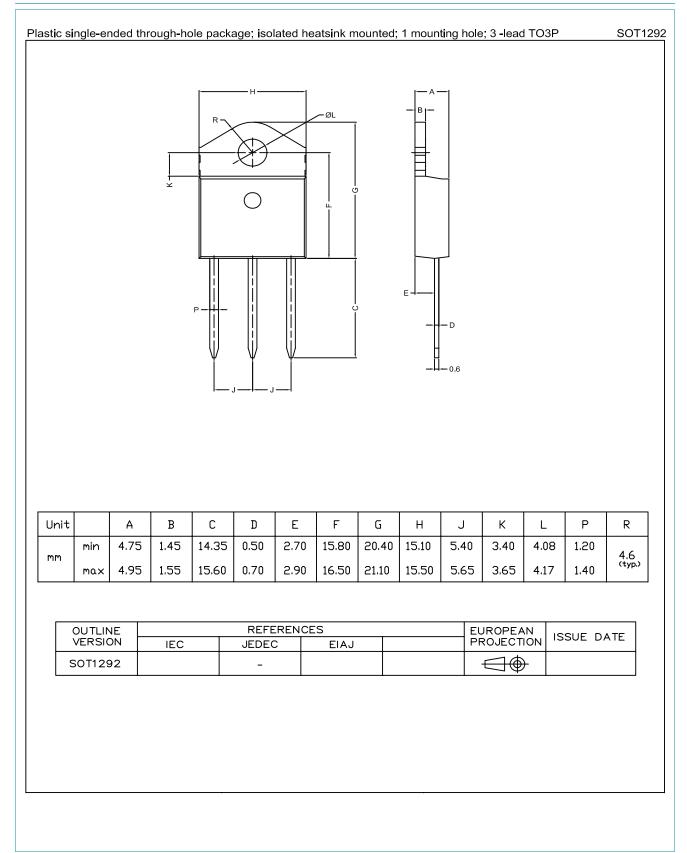
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4Q Triac



12. Package outline



13. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
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- [2] The term 'short data sheet' is explained in section "Definitions".
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